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# Dual N-Channel Power Trench<sup>®</sup> MOSFET 100 V, 25 A, 19 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 19 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 7 A
- Max  $r_{DS(on)}$  = 33 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 5.5 A
- Ideal for flexible layout in primary side of bridge topology
- Termination is Lead-free and RoHS Compliant
- 100% UIL tested
- Kelvin High Side MOSFET drive pin-out capability



### **General Description**

This device includes two 100V N-Channel MOSFETs in a dual Power (3.3 mm X 5 mm) package. HS source and LS Drain internally connected for half/full bridge, low source inductance package, low  $r_{DS(on)}/Qg$  FOM silicon.

#### Applications

- Synchronous Buck : Primary Switch of Half / Full bridge converter for telecom
- Motor Bridge : Primary Switch of Half / Full bridge converter for BLDC motor
- MV POL : 48V Synchronous Buck Switch



Power 3.3 x 5

### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25 °C		25		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	7	Α	
	-Pulsed		(Note 4)	80		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.1		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	1		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.1	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note	1a) 60	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note	1b) 130	

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
82100	FDMD82100	Power 3.3 x 5	13 "	12 mm	3000 units

June 2014

FDMD82100 Dual
N-Chan
inel PowerTrench <sup>®</sup>
MOSFET

Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$		100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C			70		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0$	V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				±100	nA
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250$	μΑ	2	3.3	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C			-9		mV/°C
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A			15	19	mΩ
	Static Drain to Source On Resistance	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 5.5 A			23	33	
		$V_{GS} = 10 \text{ V}, I_{D} = 7 \text{ A}$		27	35		
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 5 V, I_D = 7 A$			18		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V f = 1 MHz			805 176 8	1070 235 15	pF pF pF
R <sub>q</sub>	Gate Resistance			0.1	1.8	3.6	Ω
0	g Characteristics			0.1	1.0	0.0	
t <sub>d(on)</sub>	Turn-On Delay Time				9.4	19	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 7 A			3.2	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> =	6Ω		15	27	ns
t <sub>f</sub>	Fall Time				3.3	10	ns
0 (707)	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$			12	17	nC
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$	/ <sub>DD</sub> = 50 V		8	11	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 7 A			3.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge				2.7		nC
Drain-Sou	arce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 7 A$	(Note 2)		0.8	1.2	V
t <sub>rr</sub>	Reverse Recovery Time		, ,		46	74	ns
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 7 A, di/dt = 100 A/μs			48	77	nC



2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0 %. 3. E<sub>AS</sub> of 121 mJ is based on starting T<sub>J</sub> = 25 °C, L = 3 mH, I<sub>AS</sub> = 9 A, V<sub>DD</sub> = 100 V, V<sub>GS</sub> = 10 V. 100% tested at L = 0.1 mH, I<sub>AS</sub> = 30 A. 4. Pulse Id refers to Figure.11 Forward Bias Safe Operation Area.

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b. 130 °C/W when mounted on a minimum pad of 2 oz copper



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